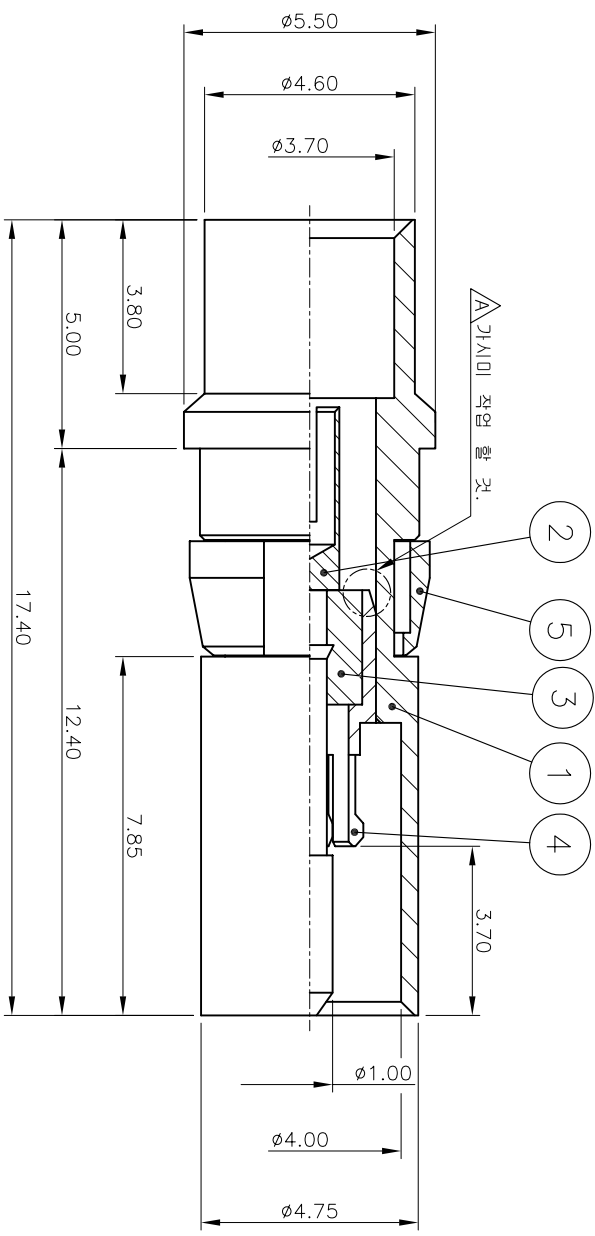


REVISION		
REV	DESCRIPTION	DATE
1	최초 개정	2002. 08. 12.
A	작업성 향상[출판200902-0004] 커시미 공정명 기입	2009. 02. 05.



5	SPRING RING	1	BeCu	Nickel Plate	DSF00031-5/1 (RB001)
4	JACK	1	BeCu	Gold Plate	DJA00069-5/1 (JP001)
3	INSULATOR	1	TEFLON	White	DIN00893-N/1 (HP002)
2	CONTACT	1	BeCu	Gold Plate	DCT01176-5/1 (EP003)
1	BODY	1	MBSBD	Gold Plate	DBD01206-5/1 (DP002)
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE	 RF & MICROWAVE TECHNOLOGY Tel: 82-32-347-8015 Fax: 82-32-347-8017			
	Angle	2009. 02. 05.				
MATERIAL	$\pm 1^{\circ}$	APPROVED BY	KJ COMITECH CO.,LTD.			
		CHECKED BY	26PKZ50 SP 141F(50Ω)			
FINISH	-	DRAWN BY	A4			
		SCALE	DWG NO. CND1747-7/1(K395-002-000)			
	-	2/1	UNIT	REVISION		
		mm		R	SHEET	
				1	1 of 1	